Overview

HP EliteBook 645 14 inch G10 Notebook PC



Left

- 1. Internal Microphones (2)
- 2. Webcam LED (Optional)
- 3. 5MP IR, HD TNR and HD TNR+IR Camera (Optional)
- **4.** Camera Shutter (Only available with webcam)
- 5. IR Camera LED (Optional)
- 6. NFC Sensor

- 7. Clickpad
- 8. Smartcard Reader (Optional)
- 9. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 10. Ethernet Port (RJ-45)
- 11. Nano Security Lock Slot (Lock sold separately)



Overview



Right

- 1. Power Button Key
- 2. Speakers
- 3. Power Connector
- SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
- SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 6. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 7. HDMI 2.1 Port (Cable not included)
- 8. Audio Combo Jack
- 9. External SIM Card Slot (Optional)
- **10.** Touch Fingerprint Sensor (Select Models)



QuickSpecs

Overview

At a Glance

- Choice of AMD Barcelo™ 7000 series mobile processors, R7, R5 and R3
- Preinstalled with Windows 11 Pro, other Windows OS or FreeDOS
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 64 GB
- Choice of 35.56 cm (14") diagonal HD, Ultra-Wide Viewing Angle FHD, Touch or Non-Touch screen, and Privacy Panel option
- Features quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of solid state drives up to 2 TB
- Multi-layered security with HP SureStart Gen7, HP Privacy Camera, HP Sure View, HP Sure Sense, HP Sure Click, HP Secure Erase, Sure Run Gen5, Sure Recover Gen5, Touch Fingerprint reader, and Tamper Lock
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi 6E and CAT16 4G/LTE WWAN
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support HP docking options
- Passed MIL-STD 810H tests ¹
- Battery life up to 16 hours 30 minutes with the optional 51.3Whr battery
- Optimize your video calls with a 5MP+IR camera, HD+IR/HD camera and temporal noise reduction that adjusts to the lighting in your environment.
- 180° synchronized hinge allows the EliteBook to lay completely flat, without lifting the keyboard, and includes everyone with visibility from multiple angles.
- Can be wiped up to 1000 times with common household cleaning wipes²
- Synchronized hinge allows the EliteBook to ProBook to open to 177° +/- 3° without lifting the keyboard and offers visibility from multiple angles.

1. MIL-STD 810H is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

2. See wipe manufacturer's instructions for disinfecting and the HP cleaning guide for HP tested wipe solutions at http://h20195.www.2.hp.com/v2/GetDocument.aspx?docname=4AA7-7610ENW

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP EliteBook 645 14 inch G10 Notebook PC

OPERATING SYSTEMS

Preinstalled	Windows 11 Pro ¹
	Windows 11 Pro Education ¹
	Windows 11 Home - HP recommends Windows 11 Pro for business ¹
	Windows 11 Home Single Language - HP recommends Windows 11 Pro for business ¹
	Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing
	Agreement ¹
	Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) ^{1,2}
	FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

Processor ^{3,4}	Cores	Threads	L3 Cache	Max Boost Frequency ⁵	Base Frequency	Pro
AMD Ryzen™ 7 PRO-7730U	8	16	16MB	4.50GHz	2.00GHz	х
AMD Ryzen™ 7-7730U	8	16	16MB	4.50GHz	2.00GHz	
AMD Ryzen™ 5 PRO-7530U	6	12	16MB	4.50GHz	2.00GHz	х
AMD Ryzen™ 5-7530U	6	12	16MB	4.50GHz	2.00GHz	
AMD Ryzen™ 3-7330U	4	8	8MB	4.30GHz	2.30GHz	

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. AMD Max Boost frequency performance varies depending on hardware, software and overall system configuration.



CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon™ Graphics

DISPLAY

Non-Touch

35.6 cm (14") diagonal FHD UWVA eDP anti-glare, IPS, micro-edge, Narrow Bezel Bent, 250 nits, 45% NTSC for HD + IR camera and WWAN (1920 x 1080) ^{6,7,8}

35.6 cm (14") diagonal FHD UWVA eDP anti-glare, IPS, Low Blue Light, 400 nits, 100% sRGB for 5MP + IR camera (1920x1080) with HP Eye Ease ^{6,7,8}

35.6 cm (14") diagonal, FHD UWVA eDP1.4 w/o PSR, anti-glare, Narrow Bezel Bent, 250 nits, 45%, no mic and WWAN (1920 x 1080) ^{6,7,8}

35.6 cm (14") diagonal, FHD UWVA eDP1.4 w/o PSR, anti-glare, Narrow Bezel Bent, 250 nits, 45%, no mic (1920 x 1080) ^{6,7,8} 35.6 cm (14") diagonal FHD UWVA eDP anti-glare, Low Power, Low Blue Light, 400 nits, 100% sRGB for HD + IR camera and WWAN (1920x1080) with HP Eye Ease ^{6,7,8}

35.6 cm (14") diagonal FHD UWVA anti-glare, IPS, Low Blue Light, 1000 nits, 100% sRGB for 5MP + IR camera, HP Sure View Gen4 integrated privacy screen with HP Eye Ease (1920x1080) ^{6,7,8,9,10}

35.6 cm (14") diagonal, FHD UWVA, IPS, micro edge, eDP1.2 w/o PSR, Anti-Glare, 250 nits, 45% NTSC Narrow Bezel bent (1920x1080) ^{6,7,8}

35.6 cm (14") diagonal, FHD UWVA, eDP, IPS, micro edge, Anti-Glare, 250 nits, 45% NTSC Narrow Bezel bent for HD camera (1920x1080) ^{6,7,8}

35.6 cm (14") diagonal, FHD UWVA, eDP, IPS, micro edge, Anti-Glare, Narrow Bezel bent, 250 nits, 45% NTSC for HD camera and WWAN (1920x1080) ^{6,7,8}

35.6 cm (14") diagonal, HD SVA eDP 1.2 w/o PSR, Anti-Glare, 250 nits, 45% NTSC Narrow Bezel bent (1366x768) ^{6,7,8} 35.6 cm (14") diagonal HD SVA eDP anti-glare narrow bezel bent, 250 nits, 45% NTSC for HD Camera (1366x768) ^{6,7,89}

Touch

35.6 cm (14") diagonal, FHD UWVA, eDP, IPS, micro edge, Anti-Glare, Narrow Bezel bent touch-on-panel screen 250 nits, 45% NTSC for HD camera (1920x1080) ^{6,7,8,10}

Display Size (Diagonal)

14" diagonal 35.6 cm (14") diagonal

6. HD content required to view HD images.

7. Sold separately or as an optional feature.

8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

9. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase

and is designed to function in landscape orientation.

10.Actual brightness will be lower with touchscreen or Sure View.



DOCKING (Sold Separately)

Docking station model #1 Docking station model #2 Docking station model #3 Docking station model #4 Docking station model #5 HP Thunderbolt 120W G4 Dock HP Thunderbolt 280W G4 Dock HP USB-C Dock G5 HP USB-C/A Universal Dock G2 HP USB-C G5 Essential Dock

For additional aftermarket options and docking specs please see page 42.

STORAGE AND DRIVES

Primary Storage

2 TB PCIe[®] Gen 4x4 NVMe[™] TLC 2280 Solid State Drive ^{11,12} 1 TB PCIe[®] Gen 4x4 NVMe[™] TLC 2280 Self Encrypted OPAL2 Solid State Drive ^{11,12} 1 TB PCIe[®] Gen 4x4 NVMe[™] TLC 2280 Solid State Drive ^{11,12} 512 GB PCIe[®] NVMe[™] M.2 SSD ¹¹ 512 GB PCIe[®] Gen 4x4 NVMe[™] TLC 2280 Self Encrypted OPAL2 Solid State Drive ^{11,12} 512 GB PCIe[®] Gen 4x4 NVMe[™] TLC Solid State Drive ^{11,12} 512 GB PCIe[®] NVMe[™] M.2 SSD ^{11,12} 256 GB PCIe[®] NVMe[™] Value 2280 Self Encrypted OPAL2 Solid State Drive ¹¹

Primary M.2 Storage

256 GB PCIe[®] NVMe[™] Value 2230 2nd Solid State Drive ^{11,13}

11. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

12. Only functions at the Gen3x4 capacity with AMD Ryzen Barcelo processor

13. Secondary SSD slot (M.2 2230 form factor; Optional) is used for data storage only, not used for OS deployment, and is only available with non-WWAN base Unit AND Primary M.2 storage.

MEMORY

Maximum Memory

64 GB DDR4-3200 SDRAM 14

Memory

64 GB DDR4-3200 SDRAM (2x32GB) ¹⁴ 32 GB DDR4-3200 SDRAM (1 x 32 GB) ¹⁴ 32 GB DDR4-3200 SDRAM (2 x 16 GB) ¹⁴ 16 GB DDR4-3200 SDRAM (1 x 16 GB) ¹⁴ 16 GB DDR4-3200 SDRAM (2 x 8 GB) ¹⁴ 8 GB DDR4-3200 SDRAM (1 x 8 GB) ¹⁴ 8 GB DDR4-3200 SDRAM (2 x 4 GB) ¹⁴

Memory Slots

2 SODIMM Both slots are customer accessible / upgradeable DDR4 PC4 SODIMMS (Barcelo runs at 3200)



Supports Dual Channel Memory

14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8852CE 802.11ax 2x2 Wi-Fi 6E + Bluetooth[®] 5.3 Wireless Card ¹⁵ Mediatek RZ616 Wi-Fi 6E + Bluetooth[®] 5.3 Wireless Card ¹⁵

WWAN

Intel[®] XMM 7560 R+ LTE-Advanced Pro WWAN (Cat 16) ¹⁶

NFC

NXP NPC300 Near Field Communication Module (NFC Mirage WNC XRAV-1)

MIRACAST

Native Miracast Support 17

Ethernet

Realtek RTL8111FPH 10/100/1000 Integrated NIC ¹⁸ Realtek RTL8111HSH 10/100/1000 Integrated NIC (Non-DASH) ¹⁸

15. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

16. Gigabit-class 4G LTE module is optional and must be configured at the factory. Module designed for up to 1 Gbps download speeds as carriers deploy 5 carrier aggregation and 100Mhz channel bandwidth, requires activation and separately purchased service contract. Backwards compatible to HSPA 3G technologies. Check with service provider for coverage and availability in your area. Connection, upload, and download speeds will vary due to network, location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

17. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

18. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

Speaker Power

2W/4ohm Per speaker

Webcam

720p HD camera with Temporal Noise Reduction ^{6,7}
720p HD camera+IR Camera with Temporal Noise Reduction ^{6,78}
5MP camera+IR with Temporal Noise Reduction ^{6,7}
5 MP + IR camera for face authentication with Windows Hello

6. HD content required to view HD images. 7. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant with optional backlit function ¹⁹ **Pointing Device** Clickpad with multi-touch gesture support

Function Keys

- F1 Display Switching
- F2 Blank or SureView On/Off
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Wireless
- F12 Programmable key

Hidden Function Keys

Fn+R - Break

- Fn+S Sys Rq
- Fn+C Scroll Lock

19. Backlit keyboard is an optional feature.



SOFTWARE AND SECURITY

Preinstalled Software

Software HP Quick Drop ²⁰ HP PC Hardware Diagnostics Windows myHP HP Smart Support ²¹ HP Services Scan ²² HP Connection Optimizer HP Hotkey Support HP Hotkey Support HP Notifications HP Privacy Settings HP Power Manager Buy Microsoft Office (Sold separately)

Manageability Features

HP Connect ²⁴ HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download) ²⁵ HP Client Management Script Library (download) HP Patch Assistant (download) ²⁶ HP Driver Packs (download) HP Client Catalog (download) HP Cloud Recovery

Security Management

HP Wolf Security for Business ²⁷ includes: HP Sure Click ²⁸ HP Sure Sense ²⁹ HP Sure Run ³⁰ HP Sure Recover ³¹ HP Sure Start ³² HP Tamper Lock HP Sure Admin ³³

BIOS

HP BIOSphere Gen6 ³⁴ HP Secure Erase ³⁵ Absolute Persistence Module ³⁶ BIOS Update via Network HP Wake on WLAN Secured-Core PC Enable ³⁷ TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified) HP Fingerprint Sensor ³⁸

Security

TPM Model: Nuvoton NPCT760HABYX Version: 7.2.3.1



Revision: TPM 2.0 FIPS 140-2 Compliant: Yes

Smartcard Reader Model number: Alcor AU9560 FIPS 201 Compliant: Yes

IPv6 Support Yes

FirstNet Certified Yes

The BIOS on this notebook implements ISO/IEC 19678:2015 guidelines (formerly NIST 800-147).

UEFI version: 2.7 Class: 3

20. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

21. HP Smart Support requires HP TechPulse to be installed. For more information about how to enable or to download HP Smart Support, please visit http://www.hp.com/smart-support. HP Services Scan is provided thru Windows Update and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP TechPulse follows stringent GDPR privacy regulations and is IS027001, IS027701, IS027017 and SOC2 Type2 certified for Information Security. Internet access with connection to TechPulse portal is required. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements.

22. HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP TechPulse follows stringent GDPR privacy regulations and is ISO27001, ISO27701, ISO27017 and SOC2 Type2 certified for Information Security. Internet access with connection to TechPulse portal is required. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements. Not applicable in China. 23. HP Support Assistance requires Windows and Internet Access

24. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.

25. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

26. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

27. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement

28. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.
29. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise 0S25. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

30. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.



31. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

32. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

33. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store

34. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

35. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel[®] Optane™.

36. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:

https://www.absolute.com/about/legal/agreements/absolute/

37. Secured-Core PC Enable requires an Intel[®] vPro[®], AMD Ryzen[™] Pro processor or Qualcomm[®] processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.

38. HP Fingerprint sensor is an optional feature that must be configured at purchase.



POWER

Power Supply

AC Adapter 45 Watt nPFC Standard USB Type C[®] Straight 1.8m ³⁹ AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Agle 1.8m ³⁹ AC Adapter 45 Watt Smart nPFC Standard C8 for 2 prong Barrel 4.5mm Right Angle ³⁹ AC Adapter 65 Watt nPFC Standard USB Type C[®] Straight 1.8m³⁹ AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm ³⁹ AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m ³⁹

Battery

HP Long Life 3-cell, 42.75 Wh Polymer^{40,41} HP Long Life 3-cell, 51.3 Wh Polymer ^{40,41} Compliant with UL 1642 Standard

Power Cord

3-wire plug - 1m ³⁹ 2-wire plug - 1m ³⁹

Battery Life

Up to 13 hours 30 minutes with 42.75Whr battery [HP Long Life 3-Cell, 42.75Whr Polymer, UMA graphics, AMD R7 PRO, display set to 200 nits (on a 400-nit display), 2*4G memory, 256G SSD]⁴² Up to 16 hours 30 minutes with 51.3Whr battery [HP Long Life 3-Cell, 51.3Whr Polymer, UMA graphics, AMD R7 PRO, display set to 200 nits (on a 400-nit display) (, 2*4G memory, 256G SSD]⁴²

Battery Weight

HP Long Life 3-cell - 42.75 Wh Polymer - .40 lb HP Long Life 3-cell - 51.3 Wh Polymer - .45 lb HP Long Life 3-cell - 42.75 Wh Polymer - 181.83 g HP Long Life 3-cell - 51.3 Wh Polymer - 203.56 g

39. Availability may vary by country.

40. Battery is internal and not replaceable by customer. Serviceable by warranty.

41. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

42. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.



WEIGHTS & DIMENSIONS

Product Weight Starting at 3.1 lb ⁴³ Starting at 1.4 kg ⁴³

Product Dimensions (W x D x H)

12.67 x 8.42 x 0.78 in 32.19 x 21.39 x 1.99 cm

Packaging Dimensions (W x D x H) 44

12"-15" boxes (305mm height): 1200mm x 1000mm x 1080mm

43. Weight will vary by configuration. Does not include power adapter.44. Product packaging size varies based on options chosen. Please contact your HP representative for your packaging size details.

PORTS/SLOTS

SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
 SuperSpeed USB Type-A 5Gbps signaling rate Port (1 Powered port) (USB 3.2 Gen 1)
 AC power
 HDMI 2.1 ⁴⁵
 Headphone/microphone combo jack
 Nano SIM slot for WWAN (optional)
 RJ-45
 Smart Card Reader (optional)

45. HDMI cable sold separately

SERVICE AND SUPPORT

1-year and 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.⁴⁶

46. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	
Nominal Operating Voltage Average Operating Power	19V
Integrated graphics	7.52W (Idle) Yes (AMD Radeon™ Graphics)
Discrete Graphics	
Max Operating Power	N/A
Max Operating Power	Discrete < 65W UMA < 45W"
Temperature	
Operating	32° to 95° F (0° to 35° C)
Non-operating	-4° to 140° F (-20° to 60° C)
Relative Humidity	
Operating	10% to 90%, non-condensing
Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	
Operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine
Random Vibration	
Operating	1.043 grams
Non-operating	3.5 grams
Altitude (unpressurized)	
Operating	-50 to 10,000 ft (-15.24 to 3,048 m)
Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)
Planned Industry Standard	
Certifications Regulatory Model Number	HSN-Q35C-4
CSA/UL 62368-1	Yes
ENERGY STAR®	Yes ⁴⁷
EPEAT®	EPEAT [®] Gold in the United States ⁴⁸
FCC/ICES/CISPR/VCCI	Yes
CE MARKING	Yes
GS Mark	Yes Related commodity should comply with ICO 0241 Stondards
China CCC/SRRC	Related commodity should comply with ISO 9241 Standards. Yes
Taiwan BSMI/NCC	Yes
Korea KCC/KC/KES	Yes
Ukraine NSoC/TEC	Yes
EAEU Compliance	Yes
Saudi Arabian Compliance	Yes
тсо	Yes
WW RoHS	Yes
Low Blue Light	Yes

47. Configurations of the HP EliteBook 645 14 inch G10 Notebook PC that are ENERGY STAR[®] qualified are identified as HP EliteBook 645 14 inch G10 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.



48. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

1. Actual brightness will be lower with touchscreen or HP Sure View.

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 14 inch FHD	Outline Dimensions (W x H x D)	316.170 x 186.400 (max)
(1920x1080) Anti-Glare	Active Area	309.370 x 174.020 mm (typ)
WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR	Weight	305 g (max)
bent Touch on Panel NWBZ	Diagonal Size	14.0
	Surface Treatment	Anti-Glare On-cell
	Touch Enabled	Yes ¹
	Contrast Ratio	600:1 (typ)
	Refresh Rate	60 Hz
	Brightness	250 nits ¹
	Pixel Resolution - Format	1920 x 1080 (FHD)
	Backlight	LED
	Pixel Resolution	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	6 (Hi FRC w/ condition to enable)
	Viewing Angle	UWVA 85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.30 (max)/ 2.80 (max)

14.0 in FHD (1920 x 1080) Anti-Glare UWVA Low Blue Light sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel

Outline Dimensions (W x H x D)	315.100 x 184.900 (max)
Active Area	309.370 x 174.020 mm (typ)
Weight	230g (max)
Diagonal Size	14.0
Surface Treatment	Anti-Glare
Touch Enabled	No
Contrast Ratio	1200:1 (typ)
Refresh Rate	60Hz
Brightness	400 nits ¹
Pixel Resolution - Format	1920 x 1080 (FHD)
Backlight	WLED
Pixel Resolution	RGB
Color Gamut Coverage	sRGB 100%
Color Depth	8
Viewing Angle	UWVA 89/89/89/89

hD

	Low Blue Light	Yes
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.23 (max)/1.5 (max)
Panel LCD 14-in FHD	Outline Dimensions (W x H x D)	316.170 x 186.400 (max)
(1920x1080) Anti-Glare	Active Area	309.370 x 174.020 mm (typ)
WLED UWVA 45percent cg	Weight	300 g (max)
250nits eDP 1.2 w/o PSR NWBZ bent	Diagonal Size	14.0
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	600:1 (typ)
	Refresh Rate	60Hz
	Brightness	250 nits ¹
	Pixel Resolution - Format	1920 x 1080 (FHD)
	Backlight	LED
	Pixel Resolution	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	6 (Hi FRC w/ condition to enable)
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.205 (max)/ 2.716 (max)
Panel LCD 14-in HD	Outline Dimensions (W x H x D)	316.110 x 186.370 (max)
(1366x768) Anti-Glare	Active Area	309.400 x 173.950 mm (typ)
WLED SVA 45percent cg	Weight	300 g (max)
250nits eDP 1.2 w/o PSR	Diagonal Size	14.0
NWBZ bent	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	300:1 (typ)
	Refresh Rate	60 Hz
	Brightness	250 nits ¹
	Pixel Resolution - Format	1366 x 768 (HD)
	Backlight	
	Pixel Resolution	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	6
	Viewing Angle	SVA 45/45/15/35
		נכונו ונדונד חינ

No

Low Blue Light



QuickSpecs

	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.52 (max) / 2.86 (max)
14.0 in FHD (1920 x 1080)	Outline Dimensions (W x H x D)	314.612 x 185.330 (max)
Anti-Glare UWVA Low Blue	Active Area	309.312 x 173.990 (typ)
Light sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4	Weight	230 g (max)
Plus bent LCD Panel	Diagonal Size	14.0
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	1500:1 (typ)
	Refresh Rate	60 Hz
	Brightness	1000 nits ¹
	Pixel Resolution - Format	1920 x1080 (FHD)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	sRGB 100%
	Color Depth	8
	Viewing Angle	UWVA 85/85/85
	Low Blue Light	Yes
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	ΝΑ



STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

5SD 256GB 2230 PCIe NVMe	Form Factor	M.2 2230
/alue	Capacity	256 GB
	NAND Type	Value
	Interface	PCIe NVMe
	Maximum Sequential Read	2000 MB/s ±20%
	Maximum Sequential Write	900 MB/s ±20%
	Logical Blocks	500118192
	Features	Pyrite; TRIM; L1.2
SSD 256GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
	Capacity	256GB
	NAND Type	Value
	Interface	PCIe NVMe
	Maximum Sequential Read	2000 MB/s ±20%
	Maximum Sequential Write Logical Blocks	900 MB/s ±20% 500118192
	Features	ATA Security; TRIM; L1.2
		····· ································
256GB PCIe 2280 NVMe	Form Factor	M.2 2280
Self Encrypted OPAL2	Capacity	256 GB
Value Solid State Drive	NAND Type	Opal2 Value
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	2000 MB/s ±20%
	Maximum Sequential Write	900 MB/s ±20%
	Logical Blocks	500,118,192
	Features	Pyrite 2.0; TRIM; L1.2
SSD 512GB 2280 PCIe	Form Factor	M.2 2280
NVMe Value	Capacity	512GB
	NAND Type	Value
	Interface	PCIe NVMe
	Maximum Sequential Read	2200 MB/s ±20%
	Maximum Sequential Write	1000 MB/s ±20%
	Logical Blocks	1000215216
	Features	Pyrite 2.0, TRIM; L1.2



rechnicat Specific		
512GB PCIe-4x4 2280	Form Factor	M.2 2280
NVME Self Encrypted	Capacity	512 GB
OPAL2 Three Layer Cell	NAND Type	Opal2 TLC
Solid State Drive	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s ±20%
	Maximum Sequential Write	3500 MB/s ±20%
	Logical Blocks	1,000,215,216
	Features	Pyrite 2.0, TRIM; L1.2
SSD 512GB 2280 PCIe-4x4	Form Factor	M.2 2280
NVMe Three Layer Cell	Capacity	512 GB
•	NAND Type	TLC
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s ±20%
	Maximum Sequential Write	3500 MB/s ±20%
	Logical Blocks	1,000,215,216
	Features	Pyrite 2.0, TRIM; L1.2
		,, ,
1TB PCIe-4x4 2280 NVME	Form Factor	M.2 2280
Self Encrypted OPAL2	Capacity	1 TB
Three Layer Cell Solid	NAND Type	Opal2 TLC
State Drive	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s ±20%
	Maximum Sequential Write	5000 MB/s ±20%
	Logical Blocks	2,000,409,264
	Features	Pyrite 2.0, TRIM; L1.2
SSD 1TB 2280 PCIe-4x4	Form Factor	M.2 2280
NVMe Three Layer Cell	Capacity	1 TB
	NAND Type	TLC
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s ±20%
	Maximum Sequential Write	5000 MB/s ±20%
	Logical Blocks	2,000,409,264
	Features	Pyrite 2.0, TRIM; L1.2
SSD 2TB 2280 PCIe-4x4	Form Factor	M 2 2280
NVMe Three Layer Cell	Form Factor	M.2 2280
	Capacity	2 TB
	NAND Type	TLC
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s ±20%

(hp)

Maximum Sequential Write Logical Blocks Features 5000 MB/s ±20% 4,000,797,360 Pyrite 2.0, TRIM; L1.2



NETWORKING/COMMUNICATIONS

Realtek RTL8852CE 802.11ax 2x2 Wi-Fi 6E + Bluetooth® 5.3 Wireless Card (802.11ax 2x2, supporting gigabit data rate) ¹	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11b IEEE 802.11h IEEE 802.11i IEEE 802.11k
	Interoperability	Wi-Fi certified
	Frequency Band	•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, ,80MHz & 160MHz) 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security ²	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification IEEE 802.11i WAPI EAP
	Network Architecture	Ad-hoc (Peer to Peer)
	Models	Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power ³	 802.11b : +17dBm minimum 802.11g : +16dBm minimum 802.11a : +17dBm minimum 802.11n HT20(2.4GHz) : +14dBm minimum 802.11n HT40(2.4GHz) : +13dBm minimum 802.11n HT20(5GHz) : +14dBm minimum 802.11n HT40(5GHz) : +13dBm minimum



QuickSpecs

Technical Specifications		
	• 802.11ac VHT1 • 802.11ax HE40 • 802.11ax HE80 • 802.11ax HE16 • 802.11ax HE80	0(5GHz) : +10dBm minimum 60(5GHz) : +10dBm minimum 0(2.4GHz) : +12dBm minimum 0(5GHz) : +10dBm minimum 60(5GHz) : +10dBm minimum 0(6GHz) : +10dBm minimum 60(6GHz) : +10dBm minimum
Power Consumption	• Idle mode :50 r	2 W) 180 mW (WLAN Associated) nW (WLAN unassociated) ndby/Modern Standby: 10mW
Power Management		ress compliant power management It power saving mode
Receiver Sensitivity ⁴	 802.11b, 1Mbp 802.11b, 11Mb 802.11a/g, 6Ml 802.11a/g, 54N 802.11a, MCS0 802.11ac, MCS1 802.11ac, MCS1 802.11ac, MCS1 802.11ac, MCS1 802.11ax, MCS 802.11ax, MCS 802.11ax, MCS 	s : -93.5dBm maximum ps : -84dBm maximum bps : -86dBm maximum 4bps : -72dBm maximum 7 : -67dBm maximum 5 : -64dBm maximum 0(VHT80) : -84dBm maximum 9(VHT80) : -59dBm maximum 9(VHT160) : -58.5dBm maximum 11(HE40): -57dBm maximum 11(HE160): -53.5dBm maximum
Antenna type	enclosure Two embedded o	ntenna with spatial diversity, mounted in the display dual band 2.4/5/6 GHz antennas are provided to the card I MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2	MiniCard
Dimensions	•••	3 x 22.0 x 30.0 mm 57 x 12.0 x 16.0 mm
Weight	1. Type 2230 : 2. 2. Type 126: 1.3	5
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 60% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	N/A	
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.	.0/5.1/5.2/5.3 Wire	eless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant



Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported Link Topology	Microsoft Windows Bluetooth Software
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.407
Power Management Certifications	ETS 300 328 Low Voltage Directive CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range Windows BT profiles support



BT5.3

Periodic Advertisement interval Encryption key size control enhancements

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Mediatek RZ616 Wi-Fi 6E	Wireless LAN Standards	IEEE 802.11a
+ Bluetooth [®] 5.3 Wireless		IEEE 802.11b
Card(802.11ax 2x2,		IEEE 802.11g
supporting gigabit data		IEEE 802.11n
rate) ¹		IEEE 802.11ac
		IEEE 802.11ax
		IEEE 802.11d
		IEEE 802.11e
		IEEE 802.11h
		IEEE 802.11i
		IEEE 802.11j
		IEEE 802.11k
		IEEE 802.11mc
		IEEE 802.11r
		IEEE 802.11v
		IEEE 802.11w
	Interoperability	Wi-Fi certified
	Frequency Band	•802.11b/g/n/ax
		2.402 – 2.482 GHz
		•802.11a/n/ac/ax
		5.15 – 5.25 GHz
		5.25 – 5.35 GHz
		5.47 – 5.725 GHz
		5.825 – 5.850 GHz
		5.925 – 7.125 GHz
	Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
		• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
		• 802.11ac : MCS0 ~ MCS9, (20MHz, 40MHz, ,80MHz & 160MHz)
		• 802.11ax : MCS0 ~ MCS11, (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum
		OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Technical Specificati	ons	
Secu	rity²	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 (personal) certification IEEE 802.11i WAPI
Netw Mode	vork Architecture	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roan		IEEE 802.11 compliant roaming between access points
	out Power ³	2.4GHz (MIMO, typical):
Ծանր	ut Power-	• 802.11b : +18dBm • 802.11g : +16.5dBm • 802.11n/ac/ax (HT20/VHT20/HE20) : +16dBm • 802.11n/ac/ax (HT40/VHT40/HE40) : +12.5dBm
		5GHz (MIMO, typical):
		• 802.11a : +13dBm
		• 802.11n/ac/ax (HT20/VHT20/HE20) : +13.5dBm
		• 802.11n/ac/ax (HT40/VHT40/HE40) : +12.5dBm
		• 802.11ac/ax (VHT80/HE80) : +11.5dBm
		• 802.11ax HE160 : +11.5dBm
		6GHz LPI mode (MIMO, typical):: • 802.11a : 0dBm • 802.11ax HE20 : +1dBm • 802.11ax HE40 : +4dBm • 802.11ax HE80 : +7dBm • 802.11ax HE160 : +7.5dBm
Powe	er Consumption	• Transmit mode :2.5 W
		 Receive mode :2 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode :50 mW (WLAN unassociated) Connected Standby/Modern Standby: 10mW Radio disabled: 8 mW
Powe	er Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Rece	iver Sensitivity ⁴	2.4GHz (SISO): • 802.11b, 11Mbps : -82dBm maximum • 802.11g, 54Mbps : -71dBm maximum • 802.11n, MCS7 : -64dBm maximum • 802.11ac, MCS9 : -52dBm maximum • 802.11ax, MCS11(HT40): -49dBm maximum 5GHz (SISO): • 802.11a, 54Mbps : -71dBm maximum • 802.11n, MCS07 : -64dBm maximum

• 802.11ac, MCS9 : -52dBm maximum

(hp)

Technical Specific	ations		
		 802.11ax, MCS11(HE80/HE160): -46dBm maximum 6GHz (SISO): 802.11a, 54Mbps : -71dBm maximum 802.11n, MCS7 : -64dBm maximum 802.11ac, MCS9 : -52dBm maximum 802.11ax, MCS11(HE160): -46dBm maximum 	
	Antenna type	enclosure Two embedded d	ntenna with spatial diversity, mounted in the display lual band 2.4/5/6 GHz antennas are provided to the card MIMO communications and Bluetooth communications
	Form Factor	PCI-Express M.2	MiniCard
	Dimensions		3 x 22.0 x 30.0 mm
			57 x 12.0 x 16.0 mm
	Weight	1. Type 2230: 2.8 2. Type 126: 1.3 <u>c</u>	5
	Operating Voltage	3.3v +/- 9%	
	Temperature	Operating	14° to 158° F (–10° to 70° C)
			–40° to 176° F (–40° to 80° C)
	Humidity	Operating	10% to 60% (non-condensing)
	A1.1. I	Non-operating	5% to 95% (non-condensing)
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
	LED Activity	N/A	
HP Integrated Module with	-		less Card
-	Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant	
	Frequency Band	2402 to 2480 MHz	
	Number of Available	Legacy: 0~79 (1 I	
	Channels	BLE: 0~39 (2 MHz	
	Signaling Data Rate	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice	
		channels	
			onous Connection Less links 2178.1 kbps/177.1 kbps H5) or 864 kbps symmetric (3-EV5)
	Transmit Power		mponent shall operate as a Class 1.5 Bluetooth device transmit power of + 14 dBm and 10 dBm for BR and EDR,
	Power Consumption	Peak (Tx): 330 m Peak (Rx): 230 m Selective Suspen	W
	Bluetooth Software Supported Link Topology	Microsoft Window	ws Bluetooth Software
	Power Management	Microsoft Window	vs ACPI, and USB Bus Support
	Certifications		15C, Section 15.247 & 15.407
	Power Management	ETS 300 328	
	-		

Not all configuration components are available in all regions/countries. c08438687 — DA17173 — Worldwide — Version 4 — March 30, 2023

Certifications	Low Voltage Directive CE Mark
Bluetooth Software Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer
	LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels
	Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance
	LE Secure Connection- Basic/Full
	LE Privacy 1.2 –Link Layer Privacy
	LE Privacy 1.2 – Extended Scanner Filter Policies
	LE Data Packet Length Extension
	FAX Profile (FAX)
	Basic Imaging Profile (BIP)2
	Headset Profile (HSP)
	Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)
	BT5.2
	ESR9/10 Compliance
	LE Advertisement Extensions
	Channel Selection Algo
	Limited High Duty Cycle Non-Connectable Advertising
	2Mbps LE
	LE Long Range
	Windows BT profiles support
	BT5.3
	Periodic Advertisement interval
	Encryption key size control enhancements

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. Check latest software/driver release for updates on supported security features.

3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Technical Specifications

Intel® XMM™ 7560 R+ LTE-Advanced Pro ¹	Technology/Operating bands Wireless protocol standards GPS GPS bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz 3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B) 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum data rates	LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output power Maximum power consumption	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	М.2, 3042-S3 Кеу В
	Weight	6 g
	Dimensions	42 x 30 x 2.3 mm
	(Length x Width x Thickness) embedded eSIM	Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.



QuickSpecs

NFC Mirage module (NXP	Dimensions (L x W x H)	Module 25 mm by 10 mm by 2.0 mm
NPC300 I2C 10mmx17mm)	Chipset	NPC300
	System interface	12C
	NFC RF standards	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
	NFC Forum Support	Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2
	Reader (PCD-VCD) Mode	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards
	Card Emulation (PICC-VICC) Mode	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa
	Frequency	13.56 MHz
	NFC Modes Supported	Reader/Writer, Peer-to-Peer
	Raw RF Data Rates	106, 212, 424, 848 kbps
	Operating temperature	0°C to 70°C
	Storage temperature	-20°C to 125°C
	Humidity	10-90% operating 5-95% non-operating
	Supply Operating voltage	4.35 to 5.25 Volts
	I/O Voltage	1.8V or 3.3V
	Power Consumption (Booster enable, VBAT= 3.3	V, VCC_BOOST = 5V)
		Power Consumption, Typical
	Polling	7.3 mA
	Detected Test Tag Type 1	Total 283.8 mA Net Module 236.8 mA
	Detected Test Tag Type 2	Total 288.8 mA Net Module 241.8 mA
	Detected Test Tag Type 3	Total 287.7 mA Net Module 240.7 mA
	Detected Test Tag Type 4	Total 282.3 mA Net Module 235.3 mA
	Antenna	Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is external to module.



Realtek RTL8111FPH	Connector	RJ-45
10/100/1000 Integrated NIC	System Interface	PCIe + SMBus
MC.	Data rates supported	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet)
	Performance	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
	Power consumption	Cable Disconnetion: 25mW 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Management Interface	Auto MDI/MDIX Crossover cable detection
	IT Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Security & Manageability	Support DASH 1.2 compliant

Realtek RTL8111HSH 10/100/1000 Integrated NIC	Connector System Interface Data rates supported	RJ-45 PCIe + SMBus 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet)



Performance	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
Power consumption	Cable Disconnetion: 25mW 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW
Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
Management Interface	Auto MDI/MDIX Crossover cable detection
IT Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status



POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

AC Adapter 45 Watt nPFC		3.701 x 1.693 x 1.071 in (9.4x4.3x2.72cm)
Standard USB Type C [®] Straight 1.8m	Weight	0.44 lb (200 g) max (Not including power cord. Power cord varies by country.)	
	Input	100 ~ 240VAC	
		Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5% 9V: 86.7% 12V: 87.4% 15V: 87.8%
		Input frequency range	47 ~ 63Hz
		Input AC current	Max. 1.4 A at 90 Vac
	Output	Output power	5V/15W 9V/27W 12V/36W 15V/45W
		DC output	5V/9V/12V/15V
		Hold-up time	100% load 5ms at 115 Vac input
		Output current limit	<5.0A
	Connector	USB Type-C®	
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standar EN62368-1:2014+A11, U Agency approvals - C-UL- Class B, CISPR32 Class B, and K-MEPS, NOM-001 an	US, TUV/GS, TUV/PSE, EN55032 Class B, FCC CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) Id 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, lia RCM, BIS, BSMI, UAE, UKCA DoC, USB-IF,
AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m	t Dimensions (H x W x D) Weight	country)	.5x4.5x2.65cm) ncluding power cord. Power cord varies by
	Input	100 ~ 240VAC Input Efficiency	87.74 % at 115 Vac and 88.4 % at 230Vac
		Input frequency range	47 ~ 63 Hz
		Input AC current	47 ~ 63 HZ Max. 1.4 A at 90 Vac



Technical Specifi	cations		
	Output	Output power	45W
		DC output	19.5V
		Hold-up time	100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input
		Output current limit	<8.0A
	Connector	4.5mm Barrel Type	
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature) -4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standa EN62368-1:2014+A11, U Agency approvals - C-UL- Class B, CISPR32 Class B, and K-MEPS, NOM-001 a	e with LVD and EMC directives ords - IEC60950-1 and IEC62368-1 : 2018, JL62368-1 -US, TUV/GS, TUV/PSE, EN55032 Class B, FCC CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) nd 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, alia GEMS and RCM, BIS, BSMI, UAE, UKCA DoC
AC Adapter 65 Watt nPFC Standard USB Type C® Straight 1.8m	Dimensions (H x W x D) Weight	3.543 x 2.008 x 1.122 in (9.0x5.1x2.85cm) 0.53 lb (240 g) max (Not including power cord. Power cord varies by country.)	
	Input	100 ~ 240VAC	
		Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V : 81.5% 9V : 86.7% 12V : 88% 15V : 88% 20V : 89%
		Input frequency range	47 ~ 63 Hz
		Input AC current	Max. 1.6 A at 90 Vac
	Output	Output power	5V/15W 9V/27W 12V/60W 15V/60W 20V/65W
		DC output	5V/9V/12V/15V/20V
		Hold-up time	100% load 5ms at 115 Vac input
		Output current limit	<8.0A
	Connector	USB TYPE C [®]	
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)

Technical Specific	cations		
		Non-operating (storage)	
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	Worldwide safety standar EN62368-1:2014+A11, UL Agency approvals - C-UL-I Class B, CISPR32 Class B, C and K-MEPS, NOM-001 an	with LVD and EMC directives ds - IEC60950-1 and IEC62368-1 : 2018, . 62368-1 JS, TUV/GS, TUV/PSE, EN55032 Class B, FCC CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) d 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, ia RCM, BIS, BSMI, UAE, UKCA DoC
AC Adapter 65 Watt Smart	Dimensions (H x W x D)	4.016 x 2.165 x 1.181 in (1	10.2x5.5x3cm)
nPFC EM Barrel 4.5mm	Weight	0.58 lb (265 g) max (Not including power cord. Power cord varies by country.)	
	Input	100 ~ 240VAC	
		Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230Vac
		Input frequency range	47 ~ 63 Hz
		Input AC current	Max. 1.7 A at 90 Vac
	Output	Output power	65W
		DC output	19.5V
		Hold-up time	100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input
		Output current limit	<11.0A
	Connector	4.5mm Barrel Type	
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
		Humidity	20% to 95%
		Storage Humidity	10% to 95%
	EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL62368-1 Agency approvals - C-UL-US, TUV/GS, EN55032 Class B, FCC Class I CISPR32 Class B, CCC and CECP, BIS, UKCA DoC	



QuickSpecs

Technical Specifi	cations			
AC Adapter 65 Watt Smar	t Dimensions (H x W x D)	3.543 x 2.008 x 1.122 in (9.0x5.1x2.85cm) 0.55 lb (250 g) max (Not including power cord. Power cord varies by country.)		
nPFC Standard Barrel 4.5mm Right Angle 1.8m	Weight			
	Input	100 ~ 240VAC		
		Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230Vac	
		Input frequency range	47 ~ 63 Hz	
		Input AC current	Max. 1.7 A at 90 Vac	
	Output	Output power	65W	
		DC output	19.5V	
		Hold-up time	100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input	
		Output current limit	<11.0A	
	Connector	4.5mm Barrel Type		
	Environmental Design	Operating temperature	32°F to 95°F (0°to 35°C)	
		Non-operating (storage) temperature	-4°F to 185°F (-20°to 85°C)	
		Altitude	0 to 16,400 ft (0 to 5000m)	
		Humidity	20% to 95%	
		Storage Humidity	10% to 95%	
	EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives Worldwide safety standards - IEC60950-1 and IEC62368-1 : 2018, EN62368-1:2014+A11, UL62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+ and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia GEMS and RCM, BIS, BSMI, UAE, UKCA Dc		
RH 42Whr Long Life	Weight	0.18 kg (0.397 lb)		
Polymer Fast Charge 3	Cells/Type	3cell Lithium-Ion Polymer cell / 545974		
cell Battery ¹	Energy	Voltage	11.4V	
		Amp-hour capacity	3.752Ah	
		Watt-hour capacity ¹	42.75Wh	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 122° F (-10° to 60° C)	
		Optional Travel Battery Available	No	

RH 51Whr Long Life	Weight	0.2025 kg (0.446 lb)	
Polymer Fast Charge 3 cell Battery ¹	Cells/Type	3cell Lithium-Ion Polymer	cell / 566075
	Energy	Voltage	11.58V
		Amp-hour capacity	4.431Ah
		Watt-hour capacity ¹	51.3Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 122° F (-10° to 60° C)
		Optional Travel Battery Available	No



AUDIO

HD Stereo Codec	ALC3247-CG
Audio I/O Ports	Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	ALC 3247 has Embedded Class-D 2W Stereo Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio.
	Following MSFT Behavior
Sampling	Streams to be sent to/from the front and rear jacks or integrated speaker.
Wavetable Syntheses	Independent sampling rates for DAC's and ADC's;
	supports resolutions from 16 to 24-bit; 44.1 kHz: External MIC/internal MIC
	16bit,48000Hz: External SPK/Internal SPK
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
# of Channels on Line-Out	N/A
Internal Speaker	Yes

FINGERPRINT READER

ELAN 80ST
Capacitive
508 DPI
80x80 pixels
<3%
< 0.001%
2.7~3.6V
-20°C - +80°C
35mA peak
900uA
Capture Rate: 50 frame/sec
IEC 61000-4-2 4B (+15KV)
508 dpi / 4x4mm sensor area



ENVIRONMENTAL DATA

ECO-Label Certifications & declarations	 This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: IT ECO declaration US ENERGY STAR[®] US Federal Energy Management Program (FEMP) EPEAT[®] Gold registered in the United States. See http://www.epeat.net for registration status in your country. TCO Certified China Energy Conservation Program (CECP) China State Environmental Protection Administration (SEPA) Taiwan Green Mark Korea Eco-label Japan PC Green label* 			
Sustainable Impact Specifications	 Ocean-bound plastic in Speaker 5% post-consumer recycled plastic 50% recycled metal Low halogen Outside Box and corrugated cushions are 100% sustainably sourced and recyclable Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable Bulk packaging available 			
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".			
Energy Consumption (in accordance with US ENERGY STAR® test				
method) Normal Operation (Sort dle)	115VAC, 60Hz 5.57 W	230VAC, 50Hz 5.47 W	100VAC, 50Hz 5.01 W	
Normal Operation (Long dle)	0.95 W	1.31 W	1.23 W	
Sleep Off	0.95 W 0.3 W	1.31 W 0.3 W	0.84 W 0.28 W	
	model family. HP compute applicable U.S. Environme computers. If a model fam energy efficiency data liste efficiency power supply, a	ers marked with the ENERG ntal Protection Agency (EP ily does not offer ENERGY s ed is for a typically configu nd a Microsoft Windows® o	· · · · · · · · · · · · · · · · · · ·	
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short idle)	19.0 BTU/hr	18.7 BTU/hr	17.1 BTU/hr	
Normal Operation (Long idle)	3.2 BTU/hr	4.5 BTU/hr	4.2 BTU/hr	
Sleep Off	3.2 BTU/hr 1.0 BTU/hr	4.5 BTU/hr 1.0 BTU/hr	2.9 BTU/hr 1.0 BTU/hr	
			easured watts, assuming the service level is	



	Sound Power	Sound Pr		
	(L _{WAd} , bels)	(L _{pAm} , de	cibels)	
2.6 1		14.	3	
2.6 1		14.	4.3	
	3.6	25.	5.6	
features and	This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.			
 This product is in compliance with the Restrictions of Hazardous Substances (RoH directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Sa Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold lev www.epeat.net Plastics parts weighing over 25 grams used in the product are marked per IS0114 IS01043. This product is 93.3% recycle-able when properly disposed of at end of life. 		al and Electronic tate of California; Safe dard at the Gold level, see marked per ISO11469 and		
External:	PAPER/Corrugated		230 g	
	PAPER/Paperboard		51 g	
	PAPER/Molded Pulp		61 g	
Internal:	•	w density-LDPE	9 g	
 HP Inc. complies fully with materials regulations. We were among the first companies to ext the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Direct o our products worldwide through the HP GSE. HP has contributed to the development of reclegislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in promoting industry elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS 		bstances (RoHS) Directive he development of related n promoting industry-wide of additional oHS legislation that the new EU RoHS		
requirements for virtually all relevant products by July 2013, and we will cont scope of the commitment to include further restricted substances as regulation evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position			gulations continue to	
This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.htm): • Asbestos • Certain Azo Colorants • Certain Prominated Elamo Detardants		n/gen_specifications.html		
	features and period and out This dire This Equi This Drin This Drin This Drin This Drin This Soft Factorial The plastic p The corruga HP Inc. comp the restriction to our produce legislation in We believe th elimination of substances— pertains to e We met our v requirements scope of the evolve. To obtain a c This product (refer to the http://www.I): Asbu Cert	3.6 This product can be upgraded, possibly features and/or components contained period and or for up to "5" years after the end or for up to "5" years after the end of the product is in compliance we directive - 2011/65/EC. • This product is in compliance we directive - 2011/65/EC. • This product is designed to Equipment (WEEE) Directive - 2 • This product is in compliance we Drinking Water and Toxic Enfor • This product is in compliance we wew.epeat.net • Plastics parts weighing over 25 ISO1043. • This product is 93.3% recycle-ated PAPER/Corrugated PAPER/Corrugated PAPER/Molded Pulp Internal: PAPER/Corrugated PAPER/Molded Pulp Internal: PLASTIC/Polyethylene to The plastic packaging material contain The corrugated paper packaging material contain HP Inc. complies fully with materials registed the restrictions in the European Union (It to our products worldwide through the legislation in Europe, as well as China, In We believe the RoHS directive and similatelimination of substances of concern. We substances—including PVC, BFRs, and core requirements for virtually all relevant p scope of the commitment to include fur evolve. To obtain a copy of the HP RoHS Compli This product does not contain any	3.6 25. This product can be upgraded, possibly extending its useful life by seve features and/or components contained in the Spare parts are available period and or for up to "5" years after the end of production. • This product is in compliance with the Restrictions of Hazardou directive - 2011/65/CC. • This HP product is designed to comply with the Waste Electricat Equipment (WEEE) Directive - 2002/96/EC. • This product is in compliance with California Proposition 65 (St Drinking Water and Toxic Enforcement Act of 1986). • This product is in compliance with the IEEE 1680 (EPEAT) stand www.epeat.net • Plastics parts weighing over 25 grams used in the product are IS01043. • This product is 93.3% recycle-able when properly disposed of External: PAPER/Corrugated PAPER/Molded Pulp Internal: PLASTIC/Polyethylene low density-LDPE The plastic packaging material contains at least 0.0% recycled content The corrugated paper packaging materials contains at least 57.0% rec HP Inc. complies fully with materials regulations. We were among the f the restrictions in the European Union (EU) Restriction of Hazardous Su to our products worldwide through the HP GSE. HP has contributed to t legislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in elimination of substances of concern. We have supported the inclusion substances—including PVC, BFRS, and certain phthala	



	 Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Bis(2-Ethylhexyl) phthalate (DEHP) Benzyl butyl phthalate (BBP) Dibutyl phthalate (DBP) Diisobutyl phthalate (DIBP) Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) Polybroninated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental	For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf		
Information			
footnotes	 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials. Plastic cushions are made from >90% recycled plastic. Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams 		

COUNTRY OF ORIGIN

China



OCKING (Sold Separately) Docking station model #1	HP Thunderbolt 120W G4 Dock
Total number of supported displays (incl. the notebook display)	4
Max. resolutions supported	Quad 4K @60Hz
	Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode
Dock Connectors	2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook. Thunderbolt Hosts: Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host. Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz Non-Thunderbolt hosts: The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is
	multi-function mode is (1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.
Docking station model #2	HP Thunderbolt 280W G4 Dock
Total number of supported displays (incl. the notebook display)	4
Max. resolutions supported	Quad 4K @60Hz Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res mode
Dock Connectors	2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook. Thunderbolt Hosts:
	Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.
	Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz Non-Thunderbolt hosts:
	The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is
	 (1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.
Docking station model #3	HP USB-C Dock G5



Total number of supported displays	3
(incl. the notebook display) Max. resolutions supported	
Dock Connectors	Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode)
	1xHDMI, 2xDP Maximum resolution and display support is dependent on the maximum
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook.
	Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.
	Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in Multi-function mode
	The highest resolution for a non-Thunderbolt host in Multi-function mode is a
	single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.
Docking station model #4	HP USB-C/A Universal Dock G2
Total number of supported displays (incl. the notebook display)	3
Max. resolutions supported	Dual 4K @ 60Hz
	Single 5K @ 60Hz
Dock Connectors	1xHDMI, 2xDP
Technical limitations	Maximum resolution and display support is dependent on the maximum capability of the notebook.
	The best resolution for dual or triple displays is 4K UHD@ 60Hz.
	For use with the USB-A adapter that comes in the box the maximum number of
	displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host.
Docking station model #5	HP USB-C G5 Essential Dock
Total number of supported displays	3
(incl. the notebook display)	
Max. resolutions supported	For hosts that support DisplayPort 1.4 with Display Stream Compression: 3x FHD @ 60 Hz 3x QHD @ 60 Hz 3x 4K @ 60 Hz
	For hosts that support DisplayPort 1.3/1.4:
	3x FHD @ 60 Hz
	3x QHD @ 60 Hz 2x 4K @ 60 Hz
Dock Connectors	1 x HDMI, 2 x DP
Technical limitations	Video resolution depends on the capability of the host machine. This dock
	provides up to 65W of power delivery to the host machine.



QuickSpecs

Tupo	Description	Part Number
Туре Audio	Description HP Wired USB-A Stereo Headset	428K6AA
Auulo	HP Wired 3.5mm Stereo Headset	428K7AA 428K7AA
	HP 365 BT Speaker	567D3AA#ACJ
Video	HP 325 FHD USB-A Webcam	53X27AA
	HP 965 4K USB-A STR Webcam	695J5AA
Cases	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Executive 14.1 Laptop Sleeve	6B8Y3AA
	HP Renew Executive 16 Laptop Backpack	6B8Y1AA
	HP Renew Executive 16 Laptop Bag	6B8Y2AA
Docking	HP USB-C 120W G5 Dock	5TW10AA
5	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 280W G4 Dock	4JOG4AA
Hub	HP 4K USB-C Multiport Hub	6G842AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP USB-C to RJ45 Adapter G2	4Z527AA
Adapter	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
Keyboard/Combo	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 355 Compact Multi-Device BT Keyboard	692S9AA
	HP 455 Programmable Wireless Keyboard	4R177AA



	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 155 Wired Mouse and Keyboard Combo	5B8C0AA#ACJ
	HP 225 Antimicrobial Wired Mouse and Keyboard Combo	286K3AA#AB2
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 155 USB-A Wired Mouse	5B8B7AA#ACJ
	HP 235 Wireless 2.4GHz Slim Wireless Mouse	4E407AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP 435 Bluetooth 5.0 + Wireless 2.4GHz Multi-Device Wireless Mouse	3B4Q5AA
	HP 715 Rechargeable Multi-Device Bluetooth 5.0 + Wireless 2.4GHz Bluetooth Mouse	6E6F0AA
	HP 925 Ergonomic Vertical Bluetooth 5.0 + Wireless 2.4GHz Wireless Mouse	6H1A5AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB Premium Wireless Mouse	1JR31AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA
	HP 65W GaN USB-C Laptop Charger	600Q7AA
	HP 65W USB-C Laptop Charger	671R3AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
	HP 90W 4.5 mm Smart AC Power Adapter	H6Y90AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA
	HP Combination Nano Cable Lock	63B28AA
	HP Essential Combination Nano Cable Lock	63B31AA



Change Log

Date of change:	Version History:		Description of change:
March 2, 2023	V1 to V2	Added	Environmental Data
March 9, 2023	V2 to V3	Added	Battery life and Docking station
March 30, 2023	V3 to V4	Updated	At a Glance section
	V4 to V5		

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